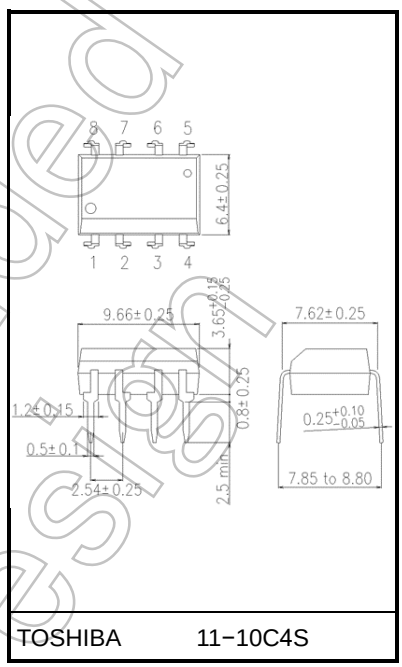
TOSHIBA Photocoupler IRED & Photo IC

6N138, 6N139

Current Loop Driver
Low Input Current Line Receiver
CMOS Logic Interface

Unit: mm



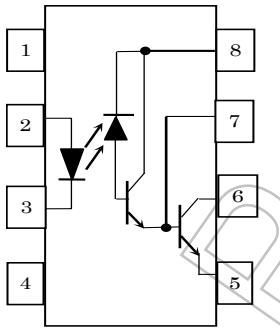
TOSHIBA 11−10C4S

Weight: 0.54 g (typ.)

The TOSHIBA 6N138 and 6N139 consists of an infrared emitting diode coupled with a split-Darlington output configuration.
A high speed Ired manufactured with an unique LPE junction, has the virtue of fast rise and fall time at low drive current.

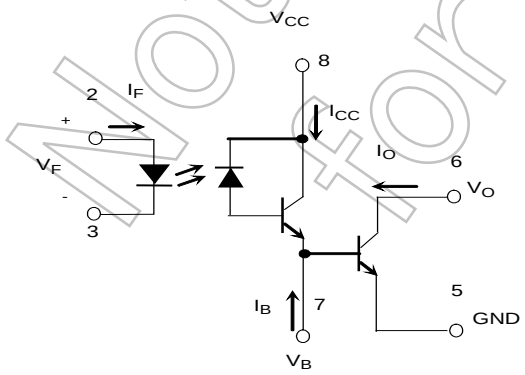
- Isolation voltage: 2500 Vrms (min)
- Current transfer ratio
  : 6N138 − 300% (min) (I_F=1.6mA)
  : 6N139 − 400% (min) (I_F=0.5mA)
- Switching time: 6N138 − t_{PHL} = 10μs (max)
  − t_{PLH} = 35μs (max)
  6N139 − t_{PHL} = 1μs (max)
  − t_{PLH} = 7μs (max)
- UL-recognized: UL 1577, File No.E67349

Pin Configuration (top view)



1 : N.C.
2 : Anode
3 : Cathode
4 : N.C.
5 : Gnd
6 : Output
7 : Output Base
8 : V_{CC}

Schematic



Start of commercial production
1988-02

Absolute Maximum Ratings (*) (Ta = 0°C to + 70°C)

Characteristics			Symbol	Rating	Unit
LED	Forward current	(Note 1)	I_F	20	mA
	Pulse forward current		I_{FP} (*1)	40	mA
	Total pulse forward current		I_{FP} (*2)	1	A
	Reverse voltage		V_R	5	V
	Diode power dissipation	(Note 2)	P_D	35	mW
Detector	Output current	(Note 3)	I_O	60	mA
	Emitter–base reverse voltage		V_{EB}	0.5	V
	Supply voltage		V_{CC} (*3)	–0.5 to 18	V
	Output voltage		V_O (*3)	–0.5 to 18	V
	Output power dissipation	(Note 4)	P_O	100	mW
Operating temperature range			T_{opr}	0 to 70	°C
Storage temperature range			T_{stg}	–55 to 125	°C
Lead solder temperature (10s) (*4)			T_{sol}	260	°C
Isolation voltage (60s, R.H.≤ 60%)			BV_S (**)	2500	V_{rms}
				3540	V_{dc}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

(*) JEDEC registered data

(**) Not registered JEDEC

(*1) 50 % duty cycle, 1 ms pulse width

(*2) Pulse width 1 μs, 300 pps

(*3) 6N138… –0.5 to 7 V

(*4) 1.6 mm below seating plane

Electrical Characteristics

Over Recommended Temperature (Ta = 0°C to 70°C, unless otherwise noted)

Characteristics		Symbol	Test Condition	Min	(*5)Typ.	Max	Unit
Current transfer ratio (Note 5, 6)	6N139	CTR(*)	I_F = 0.5 mA, V_O = 0.4 V, V_{CC} = 4.5 V	400	800	—	%
			I_F = 1.6 mA, V_O = 0.4 V, V_{CC} = 4.5V	500	900	—	
	6N138			300	600	—	
Logic low output voltage (Note 6)	6N139	V_{OL}	I_F = 1.6 mA, I_O = 6.4 mA, V_{CC} = 4.5 V	—	0.1	0.4	V
			I_F = 5 mA, I_O = 15 mA, V_{CC} = 4.5 V	—	0.1	0.4	
			I_F = 12 mA, I_O = 24 mA, V_{CC} = 4.5 V	—	0.2	0.4	
	6N138		I_F = 1.6 mA, I_O = 4.8 mA, V_{CC} = 4.5 V	—	0.1	0.4	
Logic high output current (Note 6)	6N139	I_{OH}(*)	I_F = 0 mA, V_O = V_{CC} = 18 V	—	0.05	100	μA
	6N138		I_F = 0 mA, V_O = V_{CC} = 7 V	—	0.05	250	
Logic low supply current (Note 6)		I_{CCL}	I_F = 1.6 mA, V_O = Open, V_{CC} = 5 V	—	0.2	—	mA
Logic high supply current (Note 6)		I_{CCH}	I_F = 0 mA, V_O = Open, V_{CC} = 5 V	—	10	—	nA
Input forward voltage		V_F(*)	I_F = 1.6 mA, Ta = 25 °C	—	1.65	1.7	V
Input reverse breakdown voltage		BV_R(*)	I_R = 10 μA, Ta = 25 °C	5	—	—	V
Temperature coefficient of forward voltage		$\Delta V_F / \Delta Ta$	I_F = 1.6 mA	—	−1.9	—	mV / °C
Input capacitance		C_{IN}	f = 1 MHz, V_F = 0 V	—	60	—	pF
Resistance (input−output)		R_{I-O}	V_{I-O} = 500 V (Note 7), R.H.≤ 60 %	—	10^{12}	—	Ω
Capacitance (input−output)		C_{I-O}	f = 1 MHz, V = 0 V (Note 7)	—	0.6	—	pF

(**) JEDEC registered data.

(*5) All typical values are at Ta = 25 °C and V_{CC} = 5 V, unless otherwise noted.

Switching Specifications (Ta=25°C, V_{CC}=5V, unless otherwise specified)

Characteristics		Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Propagation delay time to logic low at output (Note 6, 8)	6N139	t_{pHL}(*)	1	I_F = 0.5 mA, R_L = 4.7 kΩ	—	5	25	μs
				I_F = 12 mA, R_L = 270 Ω	—	0.2	1	
	6N138			I_F = 1.6 mA, R_L = 2.2 kΩ	—	1	10	
Propagation delay time to logic high at output (Note 6, 8)	6N139	t_{pLH}(*)	1	I_F = 0.5 mA, R_L = 4.7 kΩ	—	5	60	μs
				I_F = 12 mA, R_L = 270 Ω	—	1	7	
	6N138			I_F = 1.6 mA, R_L = 2.2 kΩ	—	4	35	
Common mode transient immunity at logic high level output (Note 9)		CM_H	2	I_F = 0 mA, R_L = 2.2 kΩ V_{CM} = 400 V_{p-p}	—	500	—	V / μs
Common mode transient immunity at logic low level output (Note 9)		CM_L	2	I_F =1.6 mA R_L = 2.2 kΩ V_{CM} = 400 V_{p-p}	—	−500	—	V / μs

(*)JEDEC registered data.

(Note 1): Derate linearly above 50 °C free−air temperature at a rate of 0.4 mA / °C

(Note 2): Derate linearly above 50 °C free−air temperature at a rate of 0.7 mW / °C

(Note 3): Derate linearly above 25 °C free−air temperature at a rate of 0.7 mA / °C

(Note 4): Derate linearly above 25 °C free−air temperature at a rate of 2.0 mW / °C

(Note 5): DC CURRENT TRANSFER RATIO is defined as the ratio of output collector current, I_O, to the forward LED input current, I_F, times 100 %.

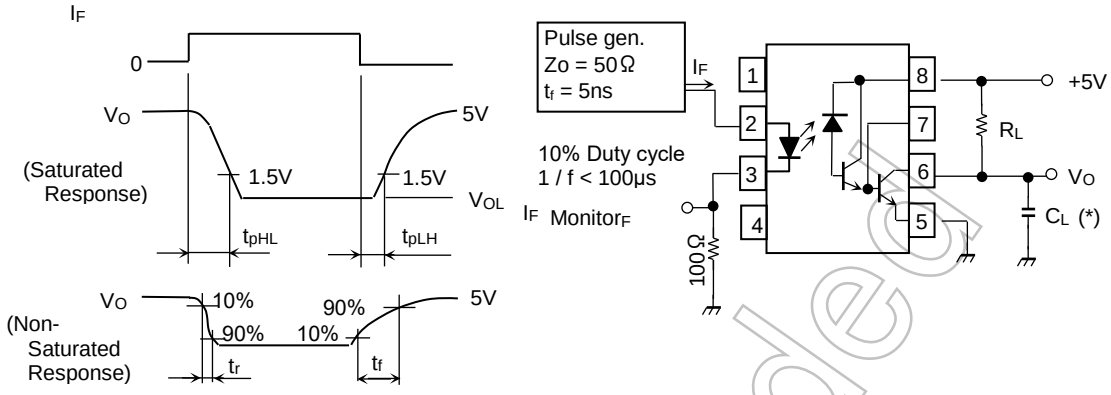
(Note 6): Pin 7 open.

(Note 7): Device considered a two−terminal device: Pins 1, 2, 3, and 4 shorted together and Pins 5, 6, 7 and 8 shorted together.

(Note 8): Use of a resistor between pin 5 and 7 will decrease gain and delay time.

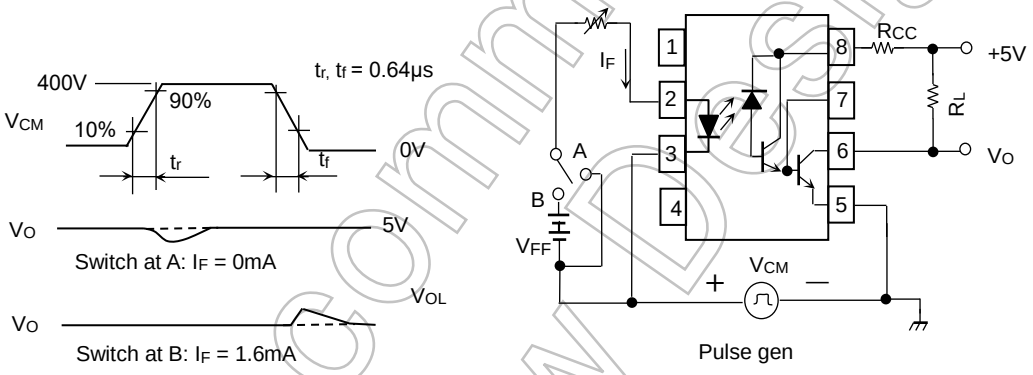
(Note 9): Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{CM} / dt on the leading edge of the common mode pulse, V_{CM}, to assure that the output will remain in a logic high state (i.e. V_O > 2.0 V).
Common mode transient immunity in Logic Low level is the maximum tolerable (negative) dV_{CM} / dt on the trailing edge of the common mode pulse signal, V_{CM}, to assure that the output will remain in a logic low state (i.e. V_O < 0.8 V).

Test Circuit 1.



(*)C_L is approximately 15pF which includes probe and stray wiring capacitance.

Test Circuit 2.



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